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### [Understanding Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

### **Applications of Embedded - FPGAs**

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

#### **Details**

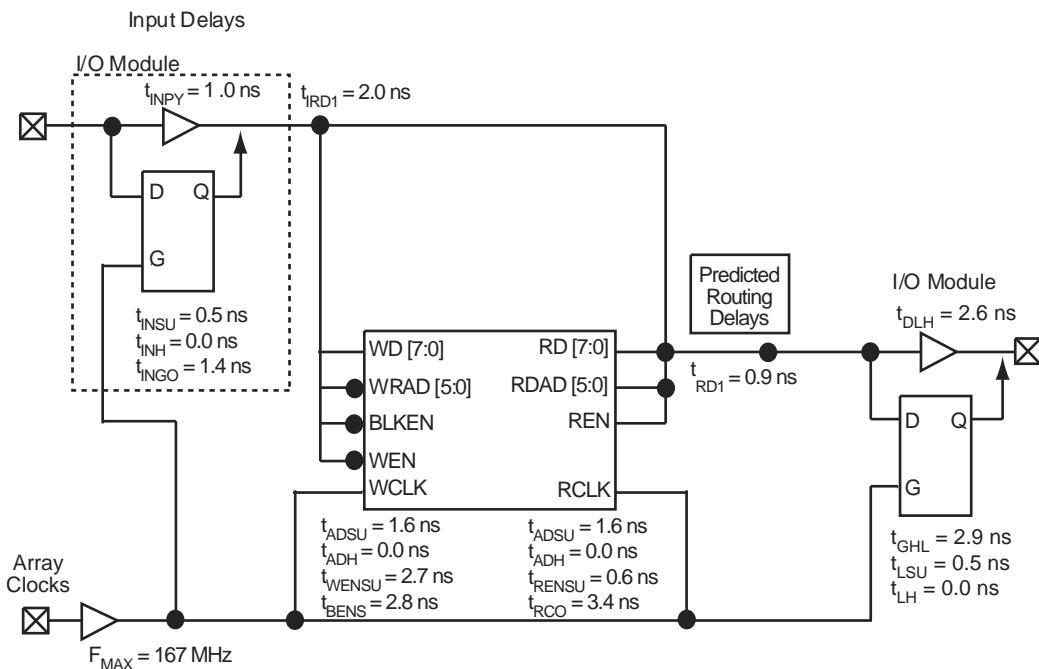
Product Status	Active
Number of LABs/CLBs	-
Number of Logic Elements/Cells	-
Total RAM Bits	-
Number of I/O	69
Number of Gates	6000
Voltage - Supply	3V ~ 3.6V, 4.75V ~ 5.25V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 70°C (TA)
Package / Case	100-BQFP
Supplier Device Package	100-PQFP (20x14)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/microchip-technology/a40mx04-pqg100">https://www.e-xfl.com/product-detail/microchip-technology/a40mx04-pqg100</a>

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**Table 1 • Product profile**

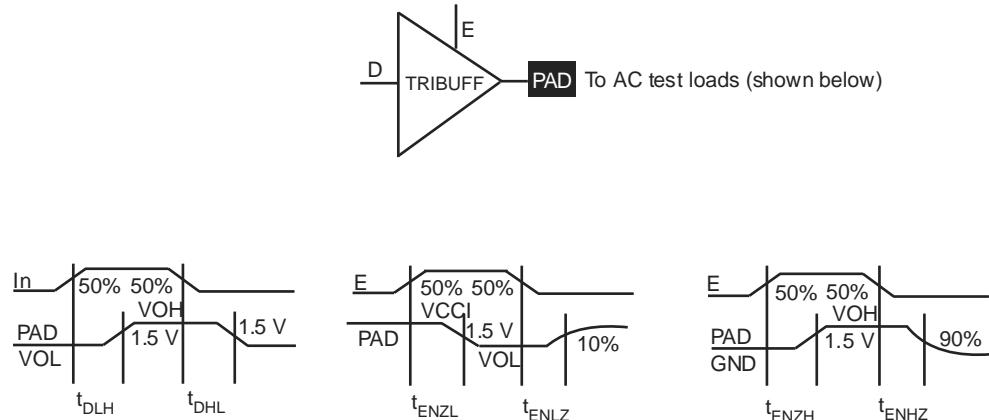
<b>Device</b>	<b>A40MX02</b>	<b>A40MX04</b>	<b>A42MX09</b>	<b>A42MX16</b>	<b>A42MX24</b>	<b>A42MX36</b>
<b>Maximum Flip-Flops</b>	147	273	516	928	1,410	1,822
<b>Clocks</b>	1	1	2	2	2	6
<b>User I/O (maximum)</b>	57	69	104	140	176	202
<b>PCI</b>	–	–	–	–	Yes	Yes
<b>Boundary Scan Test (BST)</b>	–	–	–	–	Yes	Yes
Packages (by pin count)						
PLCC	44, 68	44, 68, 84	84	84	84	–
PQFP	100	100	100, 144, 160	100, 160, 208	160, 208	208, 240
VQFP	80	80	100	100	–	–
TQFP	–	–	176	176	176	–
CQFP	–	–	–	172	–	208, 256
PBGA	–	–	–	–	–	272
CPGA	–	–	132	–	–	–

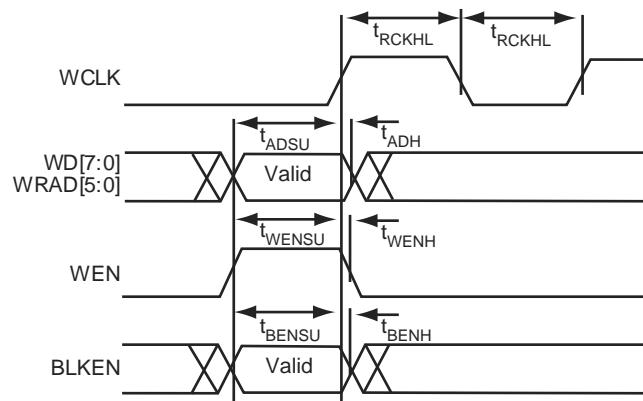
**Figure 20 • 42MX Timing Model (SRAM Functions)**

**Note:** Values are shown for A42MX36 –3 at 5.0 V worst-case commercial conditions.

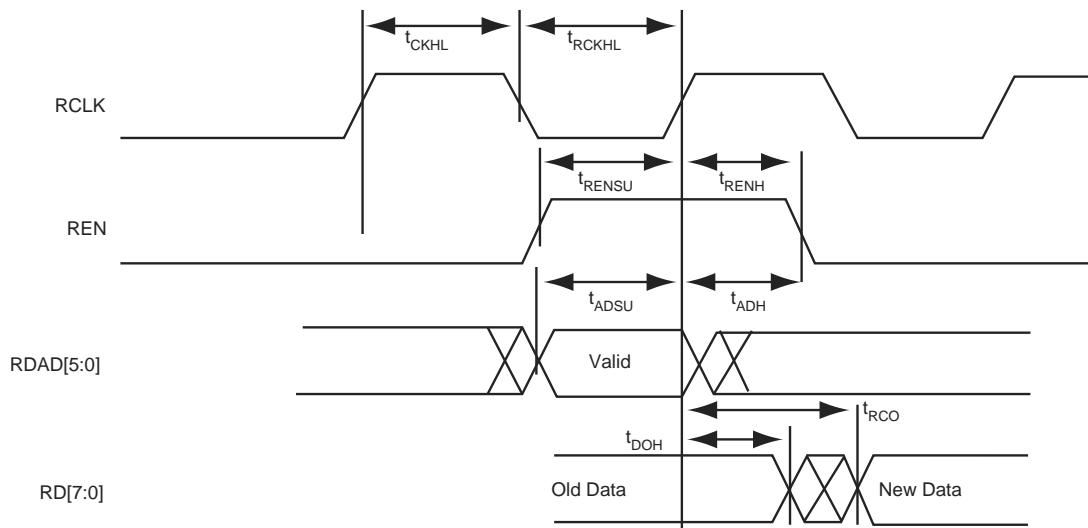
### 3.10.1 Parameter Measurement

The following figures show parameter measurement details.

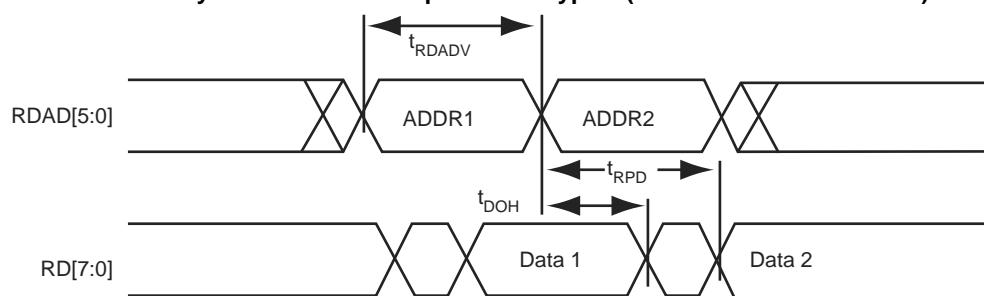
**Figure 21 • Output Buffer Delays**

**Figure 30 • 42MX SRAM Write Operation**

**Note:** Identical timing for falling edge clock

**Figure 31 • 42MX SRAM Synchronous Read Operation**

**Note:** Identical timing for falling edge clock

**Figure 32 • 42MX SRAM Asynchronous Read Operation—Type 1 (Read Address Controlled)**

**Table 38 • A42MX09 Timing Characteristics (Nominal 5.0 V Operation) (continued)(Worst-Case Commercial Conditions, VCCA = 4.75 V, TJ = 70°C)**

Parameter / Description		–3 Speed		–2 Speed		–1 Speed		Std Speed		–F Speed		Units
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
<b>Input Module Propagation Delays</b>												
t <sub>INYH</sub>	Pad-to-Y HIGH			1.0	1.2	1.3	1.6	2.2	ns			
t <sub>INYL</sub>	Pad-to-Y LOW			0.8	0.9	1.0	1.2	1.7	ns			
t <sub>INGH</sub>	G to Y HIGH			1.3	1.4	1.6	1.9	2.7	ns			
t <sub>INGL</sub>	G to Y LOW			1.3	1.4	1.6	1.9	2.7	ns			
<b>Input Module Predicted Routing Delays<sup>2</sup></b>												
t <sub>IRD1</sub>	FO = 1 Routing Delay			2.0	2.2	2.5	3.0	4.2	ns			
t <sub>IRD2</sub>	FO = 2 Routing Delay			2.3	2.5	2.9	3.4	4.7	ns			
t <sub>IRD3</sub>	FO = 3 Routing Delay			2.5	2.8	3.2	3.7	5.2	ns			
t <sub>IRD4</sub>	FO = 4 Routing Delay			2.8	3.1	3.5	4.1	5.7	ns			
t <sub>IRD8</sub>	FO = 8 Routing Delay			3.7	4.1	4.7	5.5	7.7	ns			
<b>Global Clock Network</b>												
t <sub>CKH</sub>	Input LOW to HIGH	FO = 32		2.4	2.7	3.0	3.6	5.0	ns			
		FO = 256		2.7	3.0	3.4	4.0	5.5	ns			
t <sub>CKL</sub>	Input HIGH to LOW	FO = 32		3.5	3.9	4.4	5.2	7.3	ns			
		FO = 256		3.9	4.3	4.9	5.7	8.0	ns			
t <sub>PWH</sub>	Minimum Pulse Width HIGH	FO = 32	1.2	1.4	1.5	1.8	2.5	ns				
		FO = 256	1.3	1.5	1.7	2.0	2.7	ns				
t <sub>PWL</sub>	Minimum Pulse Width LOW	FO = 32	1.2	1.4	1.5	1.8	2.5	ns				
		FO = 256	1.3	1.5	1.7	2.0	2.7	ns				
t <sub>CKSW</sub>	Maximum Skew	FO = 32		0.3	0.3	0.4	0.5	0.6	ns			
		FO = 256		0.3	0.3	0.4	0.5	0.6	ns			
t <sub>SUEXT</sub>	Input Latch External Set-Up	FO = 32	0.0	0.0	0.0	0.0	0.0	0.0	ns			
		FO = 256	0.0	0.0	0.0	0.0	0.0	0.0	ns			
t <sub>HEXT</sub>	Input Latch External Hold	FO = 32	2.3	2.6	3.0	3.5	4.9	ns				
		FO = 256	2.2	2.4	3.3	3.9	5.5	ns				
t <sub>P</sub>	Minimum Period	FO = 32	3.4	3.7	4.0	4.7	7.8	ns				
		FO = 256	3.7	4.1	4.5	5.2	8.6	ns				
f <sub>MAX</sub>	Maximum Frequency	FO = 32		296	269	247	215	129	MHz			
		FO = 256		268	244	224	195	117	MHz			

**Table 40 • A42MX16 Timing Characteristics (Nominal 5.0 V Operation) (continued)(Worst-Case Commercial Conditions, VCCA = 4.75 V, T<sub>J</sub> = 70°C)**

<b>Parameter / Description</b>		<b>-3 Speed</b>		<b>-2 Speed</b>		<b>-1 Speed</b>		<b>Std Speed</b>		<b>-F Speed</b>		<b>Units</b>
		<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	
$t_{PWL}$	Minimum Pulse Width LOW	FO = 32	3.2	3.5	4.0	4.7	6.6	ns				
		FO = 384	3.7	4.1	4.6	5.4	7.6	ns				
$t_{CKSW}$	Maximum Skew	FO = 32		0.3	0.4	0.4	0.5	0.5	0.7	ns		
		FO = 384		0.3	0.4	0.4	0.5	0.5	0.7	ns		
$t_{SUEXT}$	Input Latch External Set-Up	FO = 32	0.0	0.0	0.0	0.0	0.0	0.0	0.0	ns		
		FO = 384	0.0	0.0	0.0	0.0	0.0	0.0	0.0	ns		
$t_{HEXT}$	Input Latch External Hold	FO = 32	2.8	3.1	5.5	4.1	5.7	ns				
		FO = 384	3.2	3.5	4.0	4.7	6.6	ns				
$t_P$	Minimum Period	FO = 32	4.2	4.67	5.1	5.8	9.7	ns				
		FO = 384	4.6	5.1	5.6	6.4	10.7	ns				
$f_{MAX}$	Maximum Frequency	FO = 32		237	215	198	172	103	MHz			
		FO = 384		215	195	179	156	94	MHz			

**Table 42 • A42MX24 Timing Characteristics (Nominal 5.0 V Operation) (continued)(Worst-Case Commercial Conditions, VCCA = 4.75 V, TJ = 70°C)**

<b>Parameter / Description</b>		<b>-3 Speed</b>		<b>-2 Speed</b>		<b>-1 Speed</b>		<b>Std Speed</b>		<b>-F Speed</b>		<b>Units</b>
		<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	
<b>Input Module Propagation Delays</b>												
t <sub>INPY</sub>	Input Data Pad-to-Y	1.0		1.1		1.3		1.5		2.1		ns
t <sub>INGO</sub>	Input Latch Gate-to-Output	1.3		1.4		1.6		1.9		2.6		ns
t <sub>INH</sub>	Input Latch Hold	0.0		0.0		0.0		0.0		0.0		ns
t <sub>INSU</sub>	Input Latch Set-Up	0.5		0.5		0.6		0.7		1.0		ns
t <sub>ILA</sub>	Latch Active Pulse Width	4.7		5.2		5.9		6.9		9.7		ns

**Table 43 • A42MX24 Timing Characteristics (Nominal 3.3 V Operation) (continued)(Worst-Case Commercial Conditions, VCCA = 3.0 V, TJ = 70°C)**

<b>Parameter / Description</b>		<b>-3 Speed</b>		<b>-2 Speed</b>		<b>-1 Speed</b>		<b>Std Speed</b>		<b>-F Speed</b>	
		<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>
<b>Logic Module Sequential Timing<sup>3,4</sup></b>											
t <sub>CO</sub>	Flip-Flop Clock-to-Output		2.1		2.0		2.3		2.7		3.7 ns
t <sub>GO</sub>	Latch Gate-to-Output		3.4		1.9		2.1		2.5		3.4 ns
t <sub>SUD</sub>	Flip-Flop (Latch) Set-Up Time	0.4		0.5		0.6		0.7		0.9	ns
t <sub>HD</sub>	Flip-Flop (Latch) Hold Time	0.0		0.0		0.0		0.0		0.0	ns
t <sub>RO</sub>	Flip-Flop (Latch) Reset-to-Output		2.0		2.2		2.5		2.9		4.1 ns
t <sub>SUENA</sub>	Flip-Flop (Latch) Enable Set-Up	0.6		0.6		0.7		0.8		1.2	ns
t <sub>HENA</sub>	Flip-Flop (Latch) Enable Hold	0.0		0.0		0.0		0.0		0.0	ns
t <sub>WCLKA</sub>	Flip-Flop (Latch) Clock Active Pulse Width		4.6		5.2		5.8		6.9		9.6 ns
t <sub>WASYN</sub>	Flip-Flop (Latch) Asynchronous Pulse Width		6.1		6.8		7.7		9.0		12.6 ns
<b>Input Module Propagation Delays</b>											
t <sub>INPY</sub>	Input Data Pad-to-Y		1.4		1.6		1.8		2.2		3.0 ns
t <sub>INGO</sub>	Input Latch Gate-to-Output		1.8		1.9		2.2		2.6		3.6 ns
t <sub>INH</sub>	Input Latch Hold	0.0		0.0		0.0		0.0		0.0	ns
t <sub>INSU</sub>	Input Latch Set-Up	0.7		0.7		0.8		1.0		1.4	ns
t <sub>ILA</sub>	Latch Active Pulse Width		6.5		7.3		8.2		9.7		13.5 ns

**Table 45 • A42MX36 Timing Characteristics (Nominal 3.3 V Operation) (continued)(Worst-Case Commercial Conditions, VCCA = 3.0 V, TJ = 70°C)**

<b>Parameter / Description</b>	<b>-3 Speed</b>		<b>-2 Speed</b>		<b>-1 Speed</b>		<b>Std Speed</b>		<b>-F Speed</b>		<b>Units</b>
	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	
t <sub>RD5</sub>	FO = 8 Routing Delay		4.6		5.2		5.8		6.9		9.6 ns
t <sub>RDD</sub>	Decode-to-Output Routing Delay		0.5		0.5		0.6		0.7		1.0 ns
<b>Logic Module Sequential Timing<sup>3, 4</sup></b>											
t <sub>CO</sub>	Flip-Flop Clock-to-Output		1.8		2.0		2.3		2.7		3.7 ns
t <sub>GO</sub>	Latch Gate-to-Output		1.8		2.0		2.3		2.7		3.7 ns
t <sub>SUD</sub>	Flip-Flop (Latch) Set-Up Time	0.4		0.5		0.6		0.7		0.9	ns
t <sub>HD</sub>	Flip-Flop (Latch) Hold Time	0.0		0.0		0.0		0.0		0.0	ns
t <sub>RO</sub>	Flip-Flop (Latch) Reset-to-Output		2.2		2.4		2.7		3.2		4.5 ns
t <sub>SUENA</sub>	Flip-Flop (Latch) Enable Set-Up	1.0		1.1		1.2		1.4		2.0	ns
t <sub>HENA</sub>	Flip-Flop (Latch) Enable Hold	0.0		0.0		0.0		0.0		0.0	ns
t <sub>WCLKA</sub>	Flip-Flop (Latch) Clock Active Pulse Width		4.6		5.2		5.8		6.9		9.6 ns
t <sub>WASYN</sub>	Flip-Flop (Latch) Asynchronous Pulse Width		6.1		6.8		7.7		9.0		12.6 ns
<b>Synchronous SRAM Operations</b>											
t <sub>RC</sub>	Read Cycle Time		9.5		10.5		11.9		14.0		19.6 ns
t <sub>WC</sub>	Write Cycle Time		9.5		10.5		11.9		14.0		19.6 ns
t <sub>RCKHL</sub>	Clock HIGH/LOW Time		4.8		5.3		6.0		7.0		9.8 ns
t <sub>RCO</sub>	Data Valid After Clock HIGH/LOW		4.8		5.3		6.0		7.0		9.8 ns
t <sub>ADSU</sub>	Address/Data Set-Up Time		2.3		2.5		2.8		3.4		4.8 ns

**Table 45 • A42MX36 Timing Characteristics (Nominal 3.3 V Operation) (continued)(Worst-Case Commercial Conditions, VCCA = 3.0 V, TJ = 70°C)**

Parameter / Description	-3 Speed		-2 Speed		-1 Speed		Std Speed		-F Speed		Units
	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
<b>Input Module Predicted Routing Delays<sup>2</sup></b>											
t <sub>IRD1</sub>	FO = 1 Routing Delay		2.8	3.1	3.5	4.1	5.7	ns			
t <sub>IRD2</sub>	FO = 2 Routing Delay		3.2	3.5	4.1	4.8	6.7	ns			
t <sub>IRD3</sub>	FO = 3 Routing Delay		3.7	4.1	4.7	5.5	7.7	ns			
t <sub>IRD4</sub>	FO = 4 Routing Delay		4.2	4.6	5.3	6.2	8.7	ns			
t <sub>IRD8</sub>	FO = 8 Routing Delay		6.1	6.8	7.7	9.0	12.6	ns			
<b>Global Clock Network</b>											
t <sub>CKH</sub>	Input LOW to HIGH	FO = 32	4.6	5.1	5.7	6.7	9.3	ns			
		FO = 635	5.0	5.6	6.3	7.4	10.3	ns			
t <sub>CKL</sub>	Input HIGH to LOW	FO = 32	5.3	5.9	6.7	7.8	11.0	ns			
		FO = 635	6.8	7.6	8.6	10.1	14.1	ns			
t <sub>PWH</sub>	Minimum Pulse Width HIGH	FO = 32	2.5	2.7	3.1	3.6	5.1	ns			
		FO = 635	2.8	3.1	3.5	4.1	5.7	ns			
t <sub>PWL</sub>	Minimum Pulse Width LOW	FO = 32	2.5	2.7	3.1	3.6	5.1	ns			
		FO = 635	2.8	3.1	3.5	4.1	5.7	ns			
t <sub>CKSW</sub>	Maximum Skew	FO = 32	1.0	1.2	1.3	1.5	2.2	ns			
		FO = 635	1.0	1.2	1.3	1.5	2.2	ns			
t <sub>SUEXT</sub>	Input Latch External Set-Up	FO = 32	0.0	0.0	0.0	0.0	0.0	ns			
		FO = 635	0.0	0.0	0.0	0.0	0.0	ns			
t <sub>HEXT</sub>	Input Latch External Hold	FO = 32	4.0	4.4	5.0	5.9	8.2	ns			
		FO = 635	4.6	5.2	5.9	6.9	9.6	ns			
t <sub>P</sub>	Minimum Period (1/f <sub>MAX</sub> )	FO = 32	9.2	10.2	11.1	12.7	21.2	ns			
		FO = 635	9.9	11.0	12.0	13.8	23.0	ns			
f <sub>MAX</sub>	Maximum Datapath Frequency	FO = 32	108	98	90	79	47	MHz			
		FO = 635	100	91	83	73	44	MHz			
<b>TTL Output Module Timing<sup>5</sup></b>											
t <sub>DLH</sub>	Data-to-Pad HIGH		3.6	4.0	4.5	5.3	7.4	ns			
t <sub>DHL</sub>	Data-to-Pad LOW		4.2	4.6	5.2	6.2	8.6	ns			
t <sub>ENZH</sub>	Enable Pad Z to HIGH		3.7	4.2	4.7	5.5	7.7	ns			
t <sub>ENZL</sub>	Enable Pad Z to LOW		4.1	4.6	5.2	6.1	8.5	ns			
t <sub>ENHZ</sub>	Enable Pad HIGH to Z		7.34	8.2	9.3	10.9	15.3	ns			
<b>TTL Output Module Timing<sup>5</sup></b>											
t <sub>ENLZ</sub>	Enable Pad LOW to Z		6.9	7.6	8.7	10.2	14.3	ns			
t <sub>GLH</sub>	G-to-Pad HIGH		4.9	5.5	6.2	7.3	10.2	ns			
t <sub>GHL</sub>	G-to-Pad LOW		4.9	5.5	6.2	7.3	10.2	ns			
t <sub>LSU</sub>	I/O Latch Output Set-Up		0.7	0.7	0.8	1.0	1.4	ns			
t <sub>LH</sub>	I/O Latch Output Hold		0.0	0.0	0.0	0.0	0.0	ns			
t <sub>LCO</sub>	I/O Latch Clock-to-Out (Pad-to-Pad) 32 I/O		7.9	8.8	10.0	11.8	16.5	ns			

Clock signal to shift the Boundary Scan Test (BST) data into the device. This pin functions as an I/O when "Reserve JTAG" is not checked in the Designer Software. BST pins are only available in A42MX24 and A42MX36 devices.

#### **TDI, I/OTest Data In**

Serial data input for BST instructions and data. Data is shifted in on the rising edge of TCK. This pin functions as an I/O when "Reserve JTAG" is not checked in the Designer Software. BST pins are only available in A42MX24 and A42MX36 devices.

#### **TDO, I/OTest Data Out**

Serial data output for BST instructions and test data. This pin functions as an I/O when "Reserve JTAG" is not checked in the Designer Software. BST pins are only available in A42MX24 and A42MX36 devices.

#### **TMS, I/OTest Mode Select**

The TMS pin controls the use of the IEEE 1149.1 Boundary Scan pins (TCK, TDI, TDO). In flexible mode when the TMS pin is set LOW, the TCK, TDI and TDO pins are boundary scan pins. Once the boundary scan pins are in test mode, they will remain in that mode until the internal boundary scan state machine reaches the "logic reset" state. At this point, the boundary scan pins will be released and will function as regular I/O pins. The "logic reset" state is reached 5 TCK cycles after the TMS pin is set HIGH. In dedicated test mode, TMS functions as specified in the IEEE 1149.1 specifications. IEEE JTAG specification recommends a 10kΩ pull-up resistor on the pin. BST pins are only available in A42MX24 and A42MX36 devices.

#### **VCC, Supply Voltage**

Input supply voltage for 40MX devices

#### **VCCA, Supply Voltage**

Supply voltage for array in 42MX devices

#### **VCCI, Supply Voltage**

Supply voltage for I/Os in 42MX devices

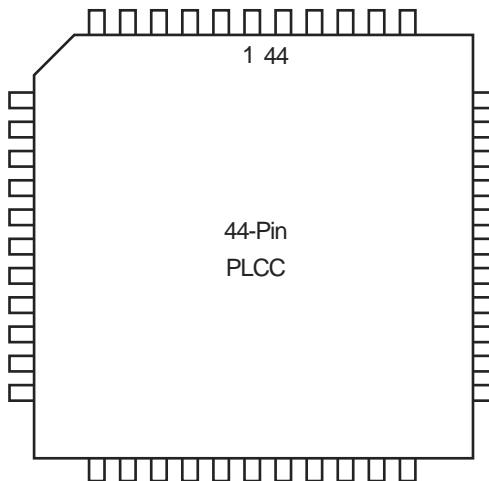
#### **WD, IOWide Decode Output**

When a wide decode module is used in a 42MX device this pin can be used as a dedicated output from the wide decode module. This direct connection eliminates additional interconnect delays associated with regular logic modules. To implement the direct I/O connection, connect an output buffer of any type to the output of the wide decode macro and place this output on one of the reserved WD pins.

## 4 Package Pin Assignments

The following figures and tables give the details of the package pin assignments.

**Figure 38 • PL44**



**Table 47 • PL44**

<b>PL44</b>		
<b>Pin Number</b>	<b>A40MX02 Function</b>	<b>A40MX04 Function</b>
1	I/O	I/O
2	I/O	I/O
3	VCC	VCC
4	I/O	I/O
5	I/O	I/O
6	I/O	I/O
7	I/O	I/O
8	I/O	I/O
9	I/O	I/O
10	GND	GND
11	I/O	I/O
12	I/O	I/O
13	I/O	I/O
14	VCC	VCC
15	I/O	I/O
16	VCC	VCC
17	I/O	I/O
18	I/O	I/O
19	I/O	I/O
20	I/O	I/O

**Table 49 • PL84**

<b>PL84</b>	<b>Pin Number</b>	<b>A40MX04 Function</b>	<b>A42MX09 Function</b>	<b>A42MX16 Function</b>	<b>A42MX24 Function</b>
47	I/O	I/O	I/O	I/O	WD, I/O
48	I/O	I/O	I/O	I/O	I/O
49	I/O	GND	GND	GND	GND
50	I/O	I/O	I/O	I/O	WD, I/O
51	I/O	I/O	I/O	I/O	WD, I/O
52	I/O	SDO, I/O	SDO, I/O	SDO, TDO, I/O	
53	I/O	I/O	I/O	I/O	I/O
54	I/O	I/O	I/O	I/O	I/O
55	I/O	I/O	I/O	I/O	I/O
56	I/O	I/O	I/O	I/O	I/O
57	I/O	I/O	I/O	I/O	I/O
58	I/O	I/O	I/O	I/O	I/O
59	I/O	I/O	I/O	I/O	I/O
60	GND	I/O	I/O	I/O	I/O
61	GND	I/O	I/O	I/O	I/O
62	I/O	I/O	I/O	I/O	TCK, I/O
63	I/O	LP	LP	LP	LP
64	CLK, I/O	VCCA	VCCA	VCCA	VCCA
65	I/O	VCCI	VCCI	VCCI	VCCI
66	MODE	I/O	I/O	I/O	I/O
67	VCC	I/O	I/O	I/O	I/O
68	VCC	I/O	I/O	I/O	I/O
69	I/O	I/O	I/O	I/O	I/O
70	I/O	GND	GND	GND	GND
71	I/O	I/O	I/O	I/O	I/O
72	SDI, I/O	I/O	I/O	I/O	I/O
73	DCLK, I/O	I/O	I/O	I/O	I/O
74	PRA, I/O	I/O	I/O	I/O	I/O
75	PRB, I/O	I/O	I/O	I/O	I/O
76	I/O	SDI, I/O	SDI, I/O	SDI, I/O	SDI, I/O
77	I/O	I/O	I/O	I/O	I/O
78	I/O	I/O	I/O	I/O	WD, I/O
79	I/O	I/O	I/O	I/O	WD, I/O
80	I/O	I/O	I/O	I/O	WD, I/O
81	I/O	PRA, I/O	PRA, I/O	PRA, I/O	PRA, I/O
82	GND	I/O	I/O	I/O	I/O
83	I/O	CLKA, I/O	CLKA, I/O	CLKA, I/O	CLKA, I/O

**Table 50 • PQ 100**

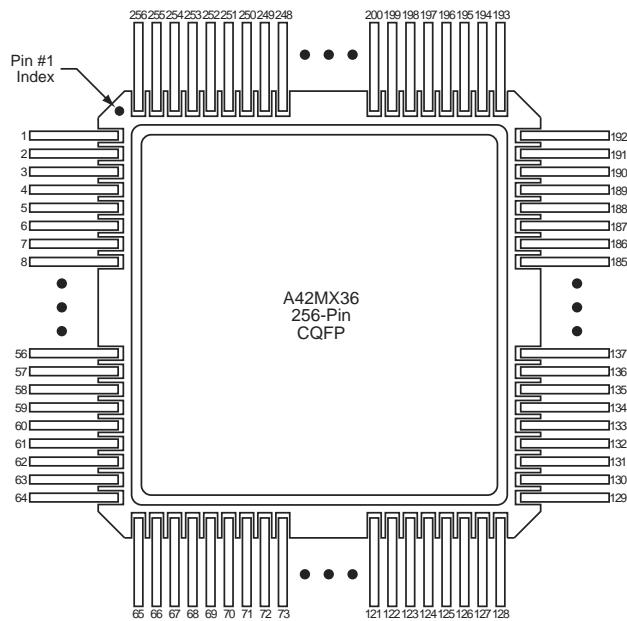
<b>PQ100</b>	<b>Pin Number</b>	<b>A40MX02 Function</b>	<b>A40MX04 Function</b>	<b>A42MX09 Function</b>	<b>A42MX16 Function</b>
19	VCC	V <sub>CC</sub>		I/O	I/O
20	I/O	I/O		I/O	I/O
21	I/O	I/O		I/O	I/O
22	I/O	I/O	GND		GND
23	I/O	I/O		I/O	I/O
24	I/O	I/O		I/O	I/O
25	I/O	I/O		I/O	I/O
26	I/O	I/O		I/O	I/O
27	NC	NC		I/O	I/O
28	NC	NC		I/O	I/O
29	NC	NC		I/O	I/O
30	NC	NC		I/O	I/O
31	NC	I/O		I/O	I/O
32	NC	I/O		I/O	I/O
33	NC	I/O		I/O	I/O
34	I/O	I/O	GND		GND
35	I/O	I/O		I/O	I/O
36	GND	GND		I/O	I/O
37	GND	GND		I/O	I/O
38	I/O	I/O		I/O	I/O
39	I/O	I/O		I/O	I/O
40	I/O	I/O	VCCA		VCCA
41	I/O	I/O		I/O	I/O
42	I/O	I/O		I/O	I/O
43	VCC	VCC		I/O	I/O
44	VCC	VCC		I/O	I/O
45	I/O	I/O		I/O	I/O
46	I/O	I/O	GND		GND
47	I/O	I/O		I/O	I/O
48	NC	I/O		I/O	I/O
49	NC	I/O		I/O	I/O
50	NC	I/O		I/O	I/O
51	NC	NC		I/O	I/O
52	NC	NC	SDO, I/O		SDO, I/O
53	NC	NC		I/O	I/O
54	NC	NC		I/O	I/O
55	NC	NC		I/O	I/O

**Table 53 • PQ208**

<b>PQ208</b>	<b>Pin Number</b>	<b>A42MX16 Function</b>	<b>A42MX24 Function</b>	<b>A42MX36 Function</b>
	132	VCCI	VCCI	VCCI
	133	VCCA	VCCA	VCCA
	134	I/O	I/O	I/O
	135	I/O	I/O	I/O
	136	VCCA	VCCA	VCCA
	137	I/O	I/O	I/O
	138	I/O	I/O	I/O
	139	I/O	I/O	I/O
	140	I/O	I/O	I/O
	141	NC	I/O	I/O
	142	I/O	I/O	I/O
	143	I/O	I/O	I/O
	144	I/O	I/O	I/O
	145	I/O	I/O	I/O
	146	NC	I/O	I/O
	147	NC	I/O	I/O
	148	NC	I/O	I/O
	149	NC	I/O	I/O
	150	GND	GND	GND
	151	I/O	I/O	I/O
	152	I/O	I/O	I/O
	153	I/O	I/O	I/O
	154	I/O	I/O	I/O
	155	I/O	I/O	I/O
	156	I/O	I/O	I/O
	157	GND	GND	GND
	158	I/O	I/O	I/O
	159	SDI, I/O	SDI, I/O	SDI, I/O
	160	I/O	I/O	I/O
	161	I/O	WD, I/O	WD, I/O
	162	I/O	WD, I/O	WD, I/O
	163	I/O	I/O	I/O
	164	VCCI	VCCI	VCCI
	165	NC	I/O	I/O
	166	NC	I/O	I/O
	167	I/O	I/O	I/O
	168	I/O	WD, I/O	WD, I/O

**Table 57 • TQ176**

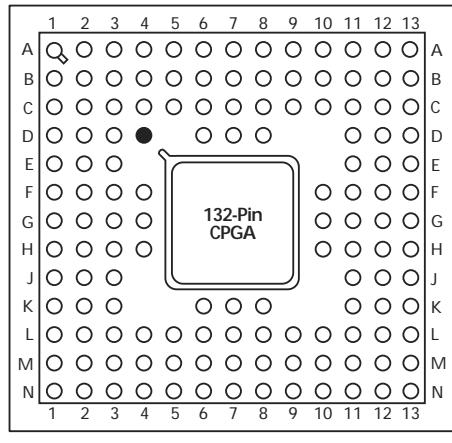
<b>TQ176</b>	<b>Pin Number</b>	<b>A42MX09 Function</b>	<b>A42MX16 Function</b>	<b>A42MX24 Function</b>
10		NC	I/O	I/O
11		NC	I/O	I/O
12		I/O	I/O	I/O
13		NC	VCCA	VCCA
14		I/O	I/O	I/O
15		I/O	I/O	I/O
16		I/O	I/O	I/O
17		I/O	I/O	I/O
18		GND	GND	GND
19		NC	I/O	I/O
20		NC	I/O	I/O
21		I/O	I/O	I/O
22		NC	I/O	I/O
23		GND	GND	GND
24		NC	VCCI	VCCI
25		VCCA	VCCA	VCCA
26		NC	I/O	I/O
27		NC	I/O	I/O
28		VCCI	VCCA	VCCA
29		NC	I/O	I/O
30		I/O	I/O	I/O
31		I/O	I/O	I/O
32		I/O	I/O	I/O
33		NC	NC	I/O
34		I/O	I/O	I/O
35		I/O	I/O	I/O
36		I/O	I/O	I/O
37		NC	I/O	I/O
38		NC	NC	I/O
39		I/O	I/O	I/O
40		I/O	I/O	I/O
41		I/O	I/O	I/O
42		I/O	I/O	I/O
43		I/O	I/O	I/O
44		I/O	I/O	I/O
45		GND	GND	GND
46		I/O	I/O	TMS, I/O

**Figure 50 • CQ256****Table 59 • CQ256**

CQ256	
Pin Number	A42MX36 Function
1	NC
2	GND
3	I/O
4	I/O
5	I/O
6	I/O
7	I/O
8	I/O
9	I/O
10	GND
11	I/O
12	I/O
13	I/O
14	I/O
15	I/O
16	I/O
17	I/O
18	I/O
19	I/O
20	I/O
21	I/O

**Table 60 • BG272**

<b>BG272</b>	
<b>Pin Number</b>	<b>A42MX36 Function</b>
Y13	I/O
Y14	I/O
Y15	I/O
Y16	I/O
Y17	I/O
Y18	WD, I/O
Y19	GND
Y20	GND

**Figure 52 • PG132**

● Orientation Pin

**Table 61 • PG132**

<b>PG132</b>	
<b>Pin Number</b>	<b>A42MX09 Function</b>
-	PMPOUT
B2	I/O
A1	MODE
B1	I/O
D3	I/O
C2	I/O
C1	I/O
D2	I/O
D1	I/O
E2	I/O
E1	I/O
F3	I/O

**Table 61 • PG132**

<b>PG132</b>	
<b>Pin Number</b>	<b>A42MX09 Function</b>
G12	VSV
F13	I/O
F12	I/O
F11	I/O
F10	I/O
E13	I/O
D13	I/O
D12	I/O
C13	I/O
B13	I/O
D11	I/O
C12	I/O
A13	I/O
C11	I/O
B12	SDI
B11	I/O
C10	I/O
A12	I/O
A11	I/O
B10	I/O
D8	I/O
A10	I/O
C8	I/O
A9	I/O
B8	PRBA
A8	I/O
B7	CLKA
A7	I/O
B6	CLKB
A6	I/O
C6	PRBB
A5	I/O
D6	I/O
A4	I/O
B4	I/O
A3	I/O
C4	I/O